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# 2.5Gb/s GaAs 1:4 Demultiplexer IC

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FMM382CG/DG

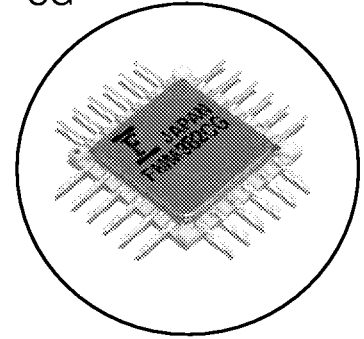
## FEATURES

- High speed operation up to 2.7 GHz from DC
- Internal phase shifter
- ECL compatible input and output
- Single -5.2 V power supply
- Stable operation at wide temperature range between 0 and 85°C
- High reliable metal/ceramic 24-pin hermetic flat package (CG)/ gullwing package (DG)

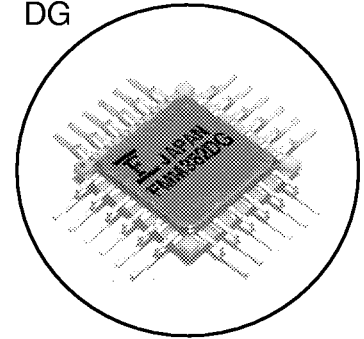
## DESCRIPTION

The FMM382CG and FMM382DG are high speed GaAs 1:4 demultiplexer ICs for multi-gigabit optical communication systems and digital test instruments. The device is designed for converting serial signal to 4-bit parallel signals at up to 2.7 GHz. An internal phase shifter is provided for arranging the 4-bit output parallel signals. The GaAs die is attached into advanced 24-pin metal/ceramic flat package designed for high speed application.

CG



DG



## ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Values	Unit
Storage Voltage	V <sub>SS</sub>	-7.0	V
Input Voltage	V <sub>TI</sub>	V <sub>SS</sub> to 0	V
Reference Voltage	V <sub>TO</sub>	-2.0 to 0	V
Power Dissipation	P <sub>D</sub>	2.0	W
Storage Temperature	T <sub>stg</sub>	-55 ~ +125	°C

## ELECTRICAL CHARACTERISTICS (T<sub>c</sub> = 25°C, V<sub>SS</sub> = -5.2V)

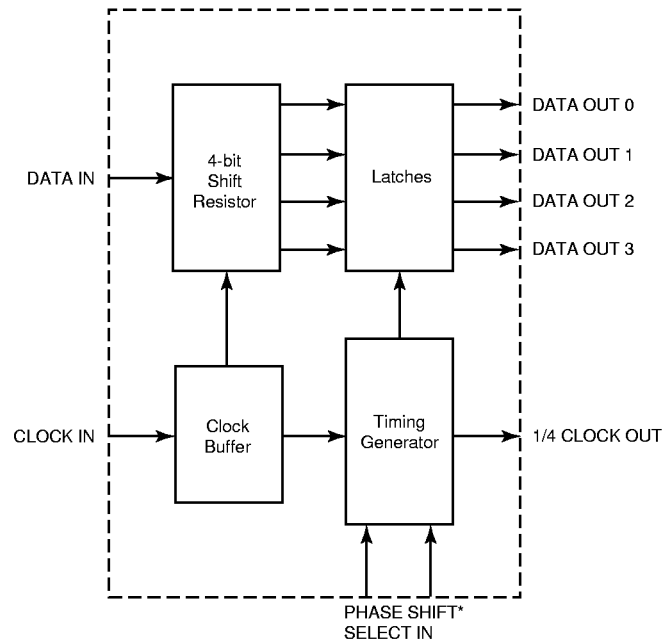
Parameter	Symbol	Conditions	Limit			Unit
			Min.	Typ.	Max.	
Supply Current	I <sub>SS</sub>		-	200	-	mA
High Level Input Voltage	V <sub>IH</sub>		-1.0	-0.9	-	V
Low Level Input Voltage	V <sub>IL</sub>		-	-1.7	-1.6	V
High Level Output Voltage	V <sub>OH</sub>	V <sub>TT</sub> =2V 50Ω Termination *20%~80%	-0.95	-	-	V
Low Level Output Voltage	V <sub>OL</sub>		-	-	-1.65	V
Output Rise Time	t <sub>r</sub> *		-	175	-	ps
Output Fall Time	t <sub>f</sub> *		-	175	-	ps
Maximum Clock Frequency	f <sub>max</sub>		2.7	-	-	GHz

## RECOMMENDED OPERATING CONDITIONS (V<sub>DD</sub> = 0V)

Parameter	Symbol	Value			Unit
		Min.	Typ.	Max.	
Supply Voltage	V <sub>SS</sub>	-5.46	-5.2	-4.94	V
Reference Voltage	V <sub>REF</sub> *	-1.4	-1.3	-1.2	V
Operating Case Temperature	T <sub>C</sub>	0	-	+65	°C

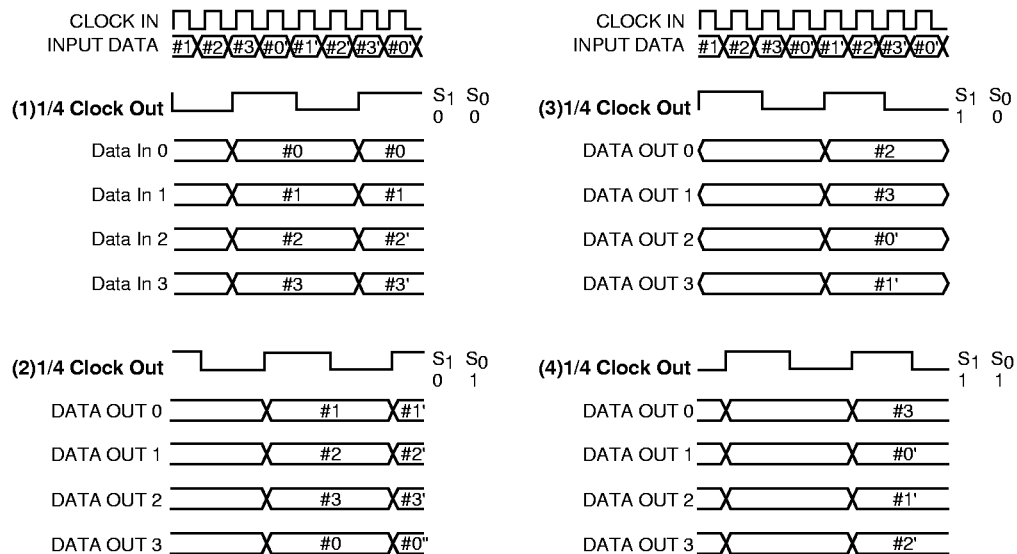
\* Note: V<sub>REF</sub> which is normally open, can be used as a bias adjusting terminal to optimize the operation frequency or output waveform.

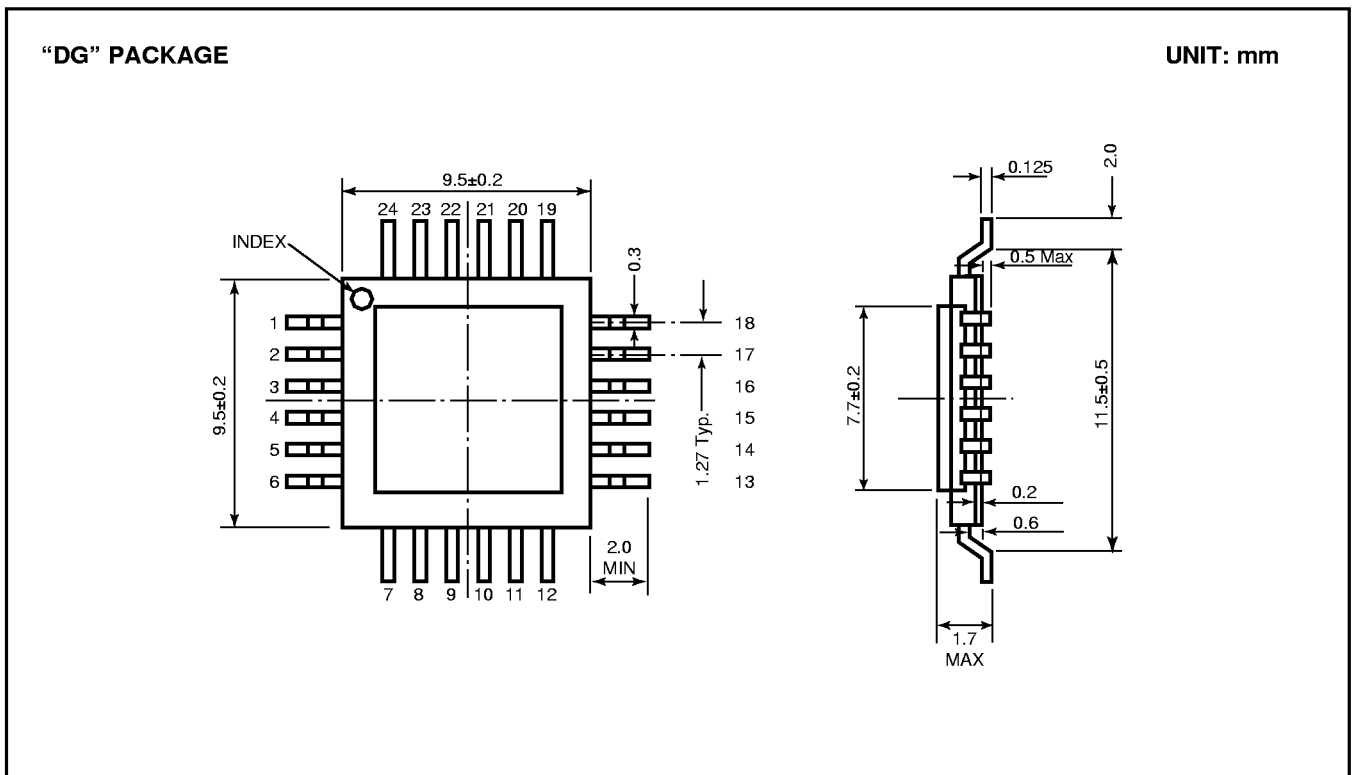
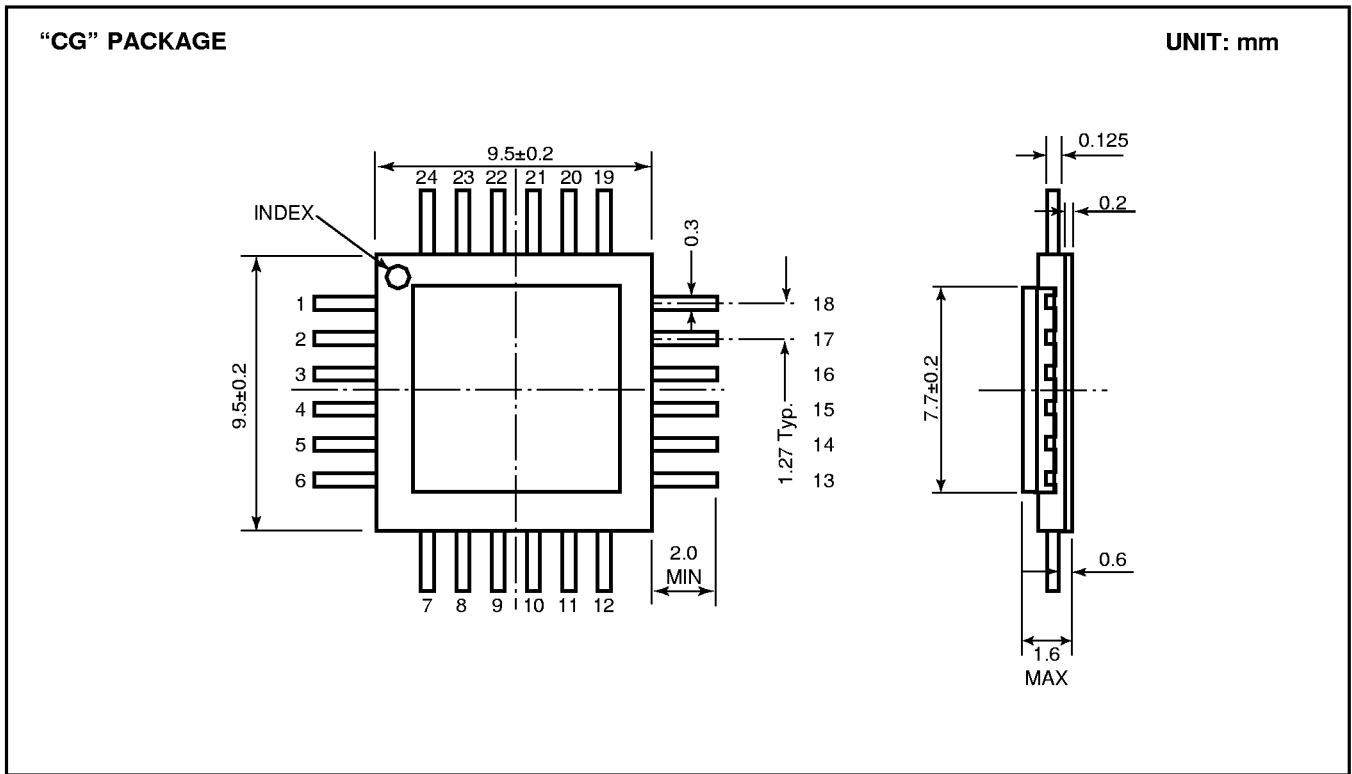
**BLOCK DIAGRAM**



\* These two input pins are used to select one of 4 phases of the internally generated 1/4 CLOCK. Each phase differs by one high speed CLOCK period in time. PHASE SHIFT (DATA ROTATION) is accomplished by providing a 2-bit static code to the pins.

**TIMING DIAGRAM**





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